SCT3040KL

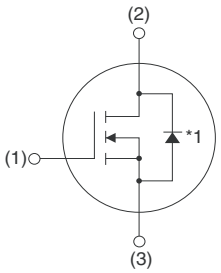
N-channel SiC power MOSFET Datasheet

V_{DSS}	1200V
$R_{DS(on)}$ (Typ.)	40mΩ
I_D	55A
P_D	262W

●Outline

TO-247N

●Inner circuit



(1) Gate
(2) Drain
(3) Source

*1 Body Diode

●Features

1) Low on-resistance
2) Fast switching speed
3) Fast reverse recovery
4) Easy to parallel
5) Simple to drive
6) Pb-free lead plating ; RoHS compliant

●Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- Induction heating
- Motor drives

●Packaging specifications

Type	Packing	Tube
	Reel size (mm)	-
	Tape width (mm)	-
	Basic ordering unit (pcs)	30
	Taping code	C11
	Marking	SCT3040KL

●Absolute maximum ratings (T_a = 25°C)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V_{DSS}	1200	V
Continuous drain current	T_c = 25°C	I_D *1	55	A
	T_c = 100°C	I_D *1	39	A
Pulsed drain current		$I_{D,pulse}$ *2	137	A
Gate - Source voltage		V_{GSS}	−4 to 22	V
Junction temperature		T_j	175	°C
Range of storage temperature		T_{stg}	−55 to +175	°C

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●Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - case	R_{thJC}	-	0.44	0.57	°C/W

●Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 1mA	1200	-	-	V
Zero gate voltage drain current	I_{DSS}	V_{DS} = 1200V, V_{GS} = 0V T_j = 25°C T_j = 150°C	- -	1 2	10 -	μA
Gate - Source leakage current	I_{GSS+}	V_{GS} = +22V, V_{DS} = 0V	-	-	100	nA
Gate - Source leakage current	I_{GSS-}	V_{GS} = −4V, V_{DS} = 0V	-	-	−100	nA
Gate threshold voltage	$V_{GS\ (th)}$	V_{DS} = 10V, I_D = 10mA	2.7	-	5.6	V
Static drain - source on - state resistance	$R_{DS(on)}$ *3	V_{GS} = 18V, I_D = 20A T_j = 25°C T_j = 125°C	- -	40 60	52 -	mΩ
Gate input resistance	R_G	f = 1MHz, open drain	-	7	-	Ω

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●Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Transconductance	g_{fs} *3	V_{DS} = 10V, I_D = 20A	-	8.3	-	S
Input capacitance	C_{iss}	V_{GS} = 0V	-	1337	-	pF
Output capacitance	C_{oss}	V_{DS} = 800V	-	76	-	
Reverse transfer capacitance	C_{rss}	f = 1MHz	-	27	-	
Effective output capacitance, energy related	$C_{o(er)}$	V_{GS} = 0V V_{DS} = 0V to 600V	-	122	-	pF
Turn - on delay time	$t_{d(on)}$ *3	V_{DD} = 400V, I_D = 18A	-	21	-	ns
Rise time	t_r *3	V_{GS} = 18V/0V	-	39	-	
Turn - off delay time	$t_{d(off)}$ *3	R_L = 22Ω	-	49	-	
Fall time	t_f *3	R_G = 0Ω	-	24	-	
Turn - on switching loss	E_{on} *3	V_{DD} = 600V, I_D=20A V_{GS} = 18V/0V R_G = 0Ω L=250μH *E_{on} includes diode reverse recovery	-	283	-	μJ
Turn - off switching loss	E_{off} *3		-	118	-	

●Gate Charge characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Total gate charge	Q_g *3	V_{DD} = 600V	-	107	-	nC
Gate - Source charge	Q_{gs} *3	I_D = 20A	-	22	-	
Gate - Drain charge	Q_{gd} *3	V_{GS} = 18V	-	41	-	
Gate plateau voltage	$V_{(plateau)}$	V_{DD} = 600V, I_D = 20A	-	9.6	-	V

*1 Limited only by maximum temperature allowed.

*2 PW ≤ 10μs, Duty cycle ≤ 1%

*3 Pulsed

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●**Body diode electrical characteristics** (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Inverse diode continuous, forward current	I_S *1	T_c = 25°C	-	-	55	A
Inverse diode direct current, pulsed	I_{SM} *2		-	-	137	A
Forward voltage	V_{SD} *3	V_{GS} = 0V, I_S = 20A	-	3.2	-	V
Reverse recovery time	t_{rr} *3	I_F = 20A, V_R = 600V di/dt = 1100A/μs	-	25	-	ns
Reverse recovery charge	Q_{rr} *3		-	115	-	nC
Peak reverse recovery current	I_{rrm} *3		-	9	-	A

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●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

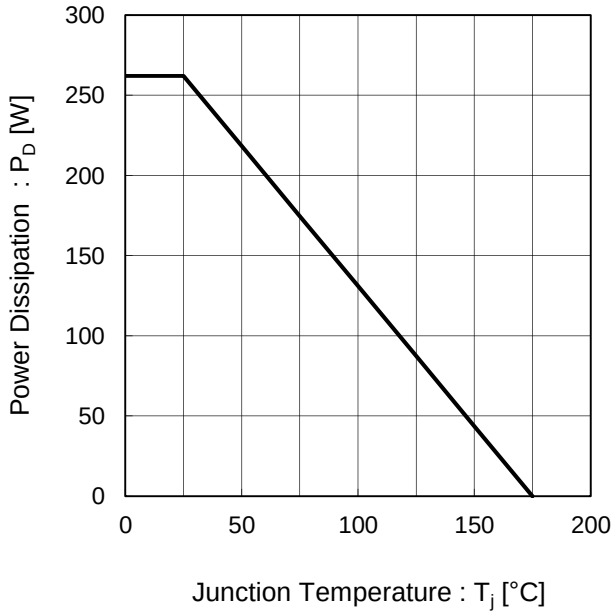


Fig.2 Maximum Safe Operating Area

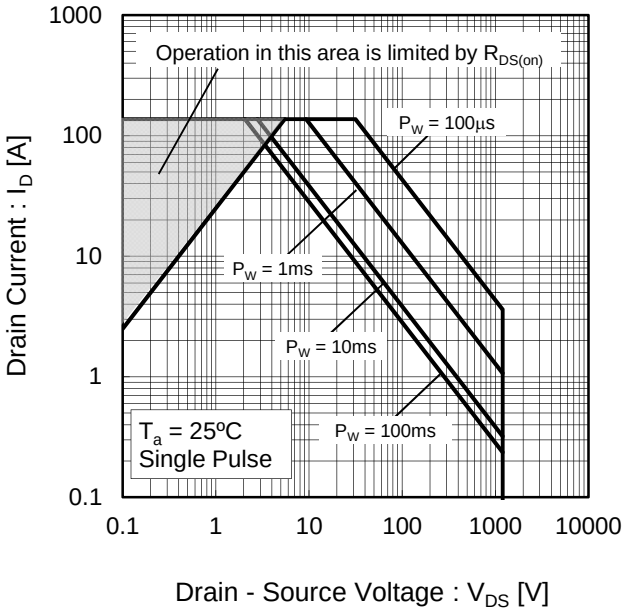
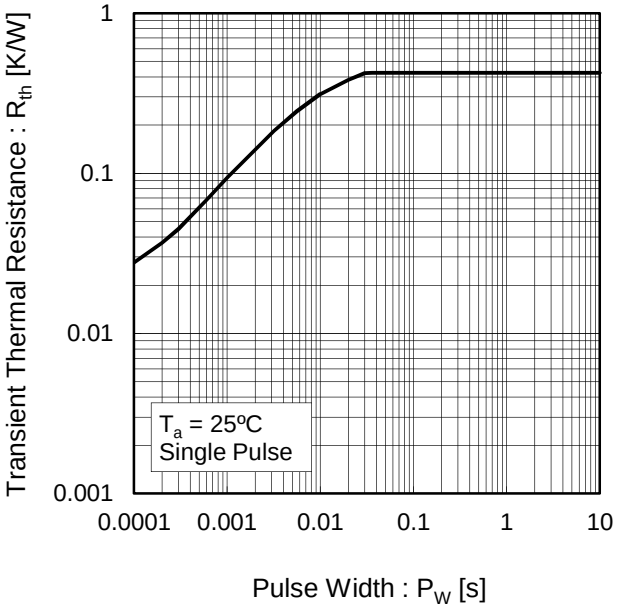


Fig.3 Typical Transient Thermal Resistance vs. Pulse Width



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●Electrical characteristic curves

Fig.4 Typical Output Characteristics(I)

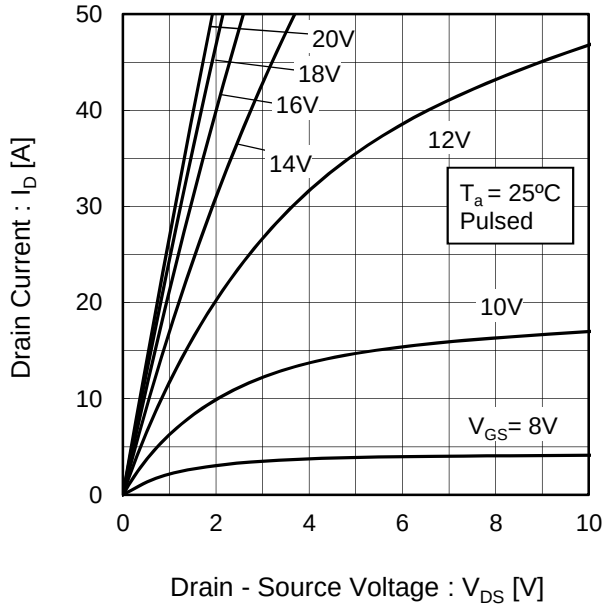


Fig.5 Typical Output Characteristics(II)

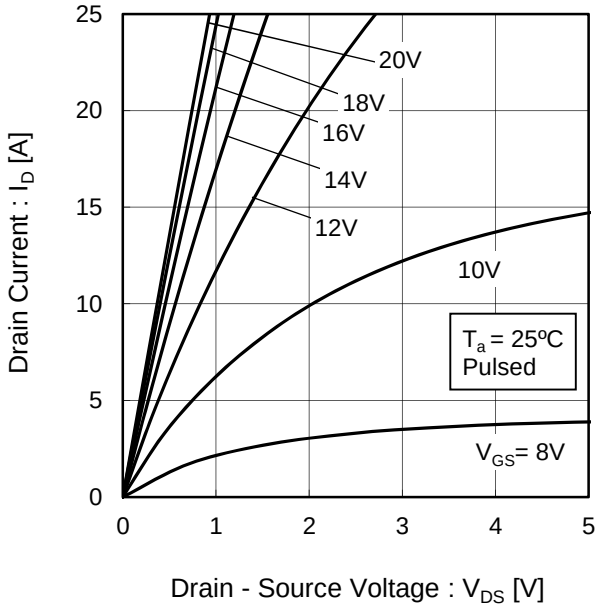


Fig.6 T_j = 150°C Typical Output Characteristics(I)

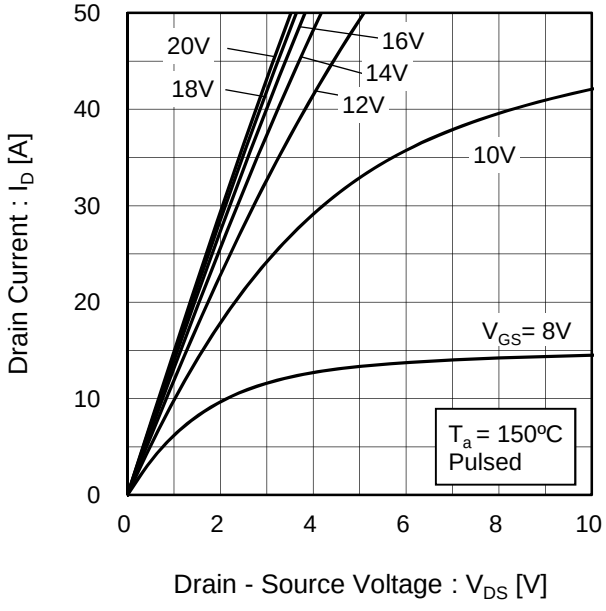
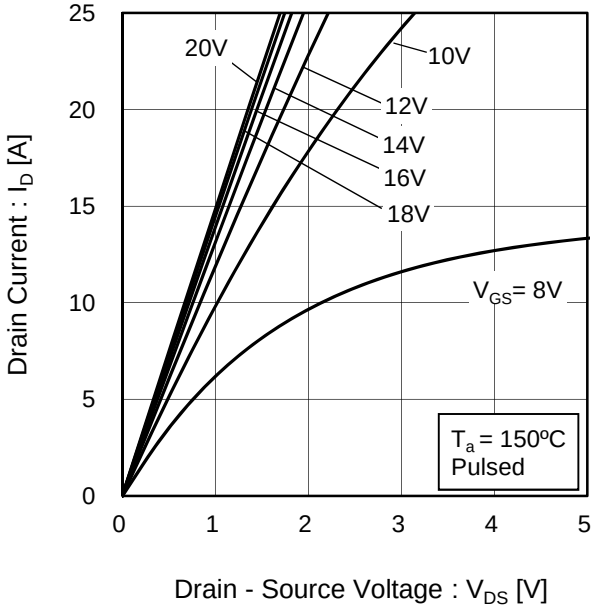


Fig.7 T_j = 150°C Typical Output Characteristics(II)



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●Electrical characteristic curves

Fig.8 Typical Transfer Characteristics (I)

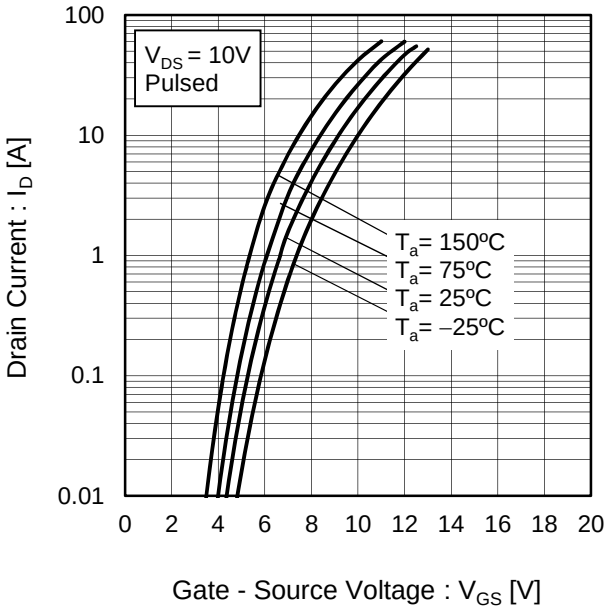


Fig.9 Typical Transfer Characteristics (II)

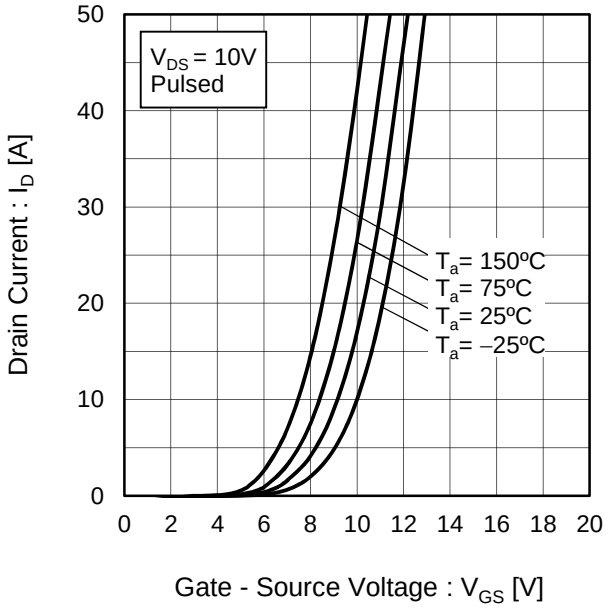


Fig.10 Gate Threshold Voltage vs. Junction Temperature

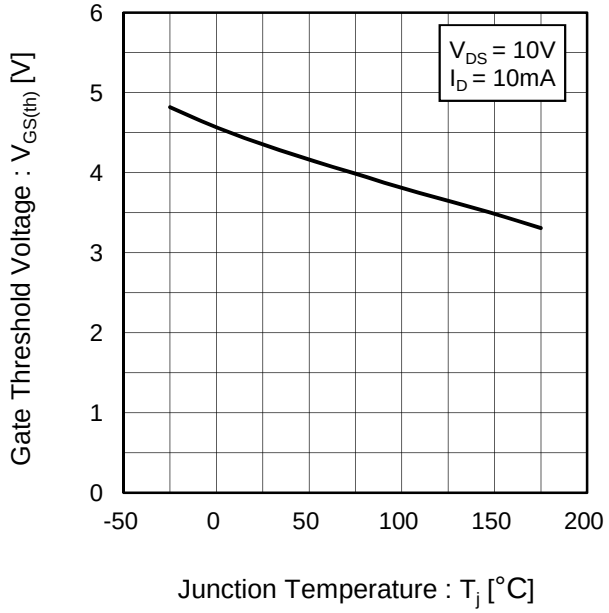
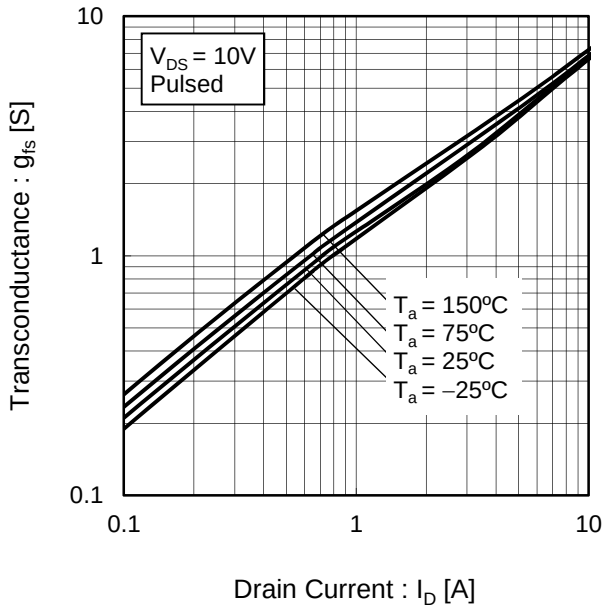


Fig.11 Transconductance vs. Drain Current



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●Electrical characteristic curves

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

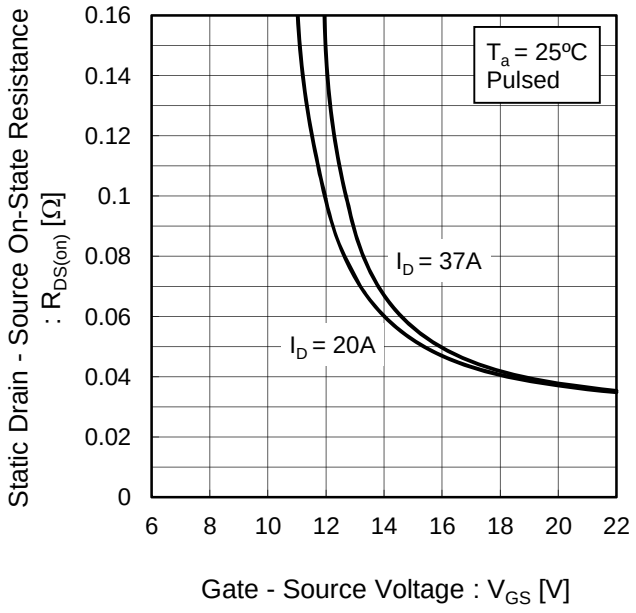


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

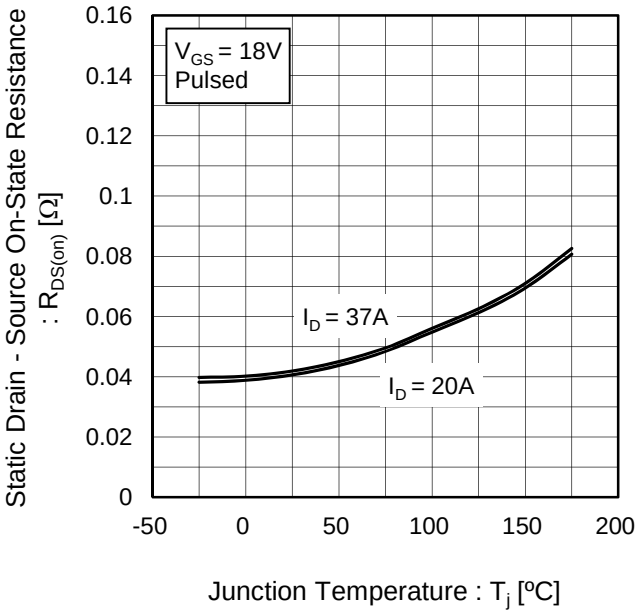
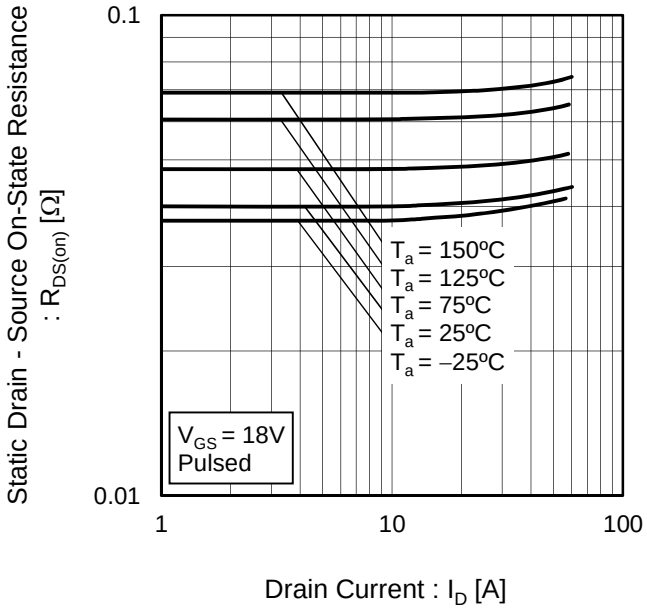


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current



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●Electrical characteristic curves

Fig.15 Typical Capacitance vs. Drain - Source Voltage

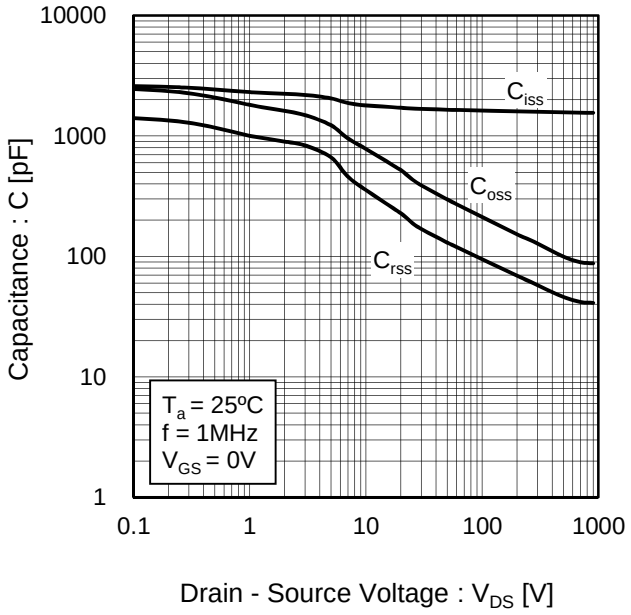


Fig.16 Coss Stored Energy

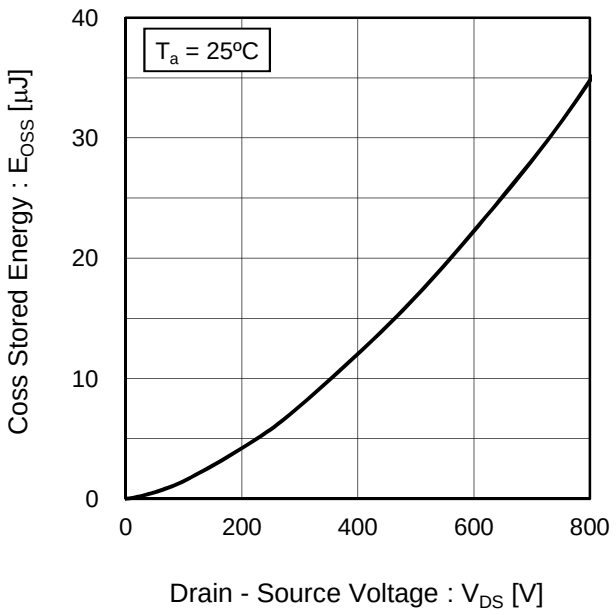


Fig.17 Switching Characteristics

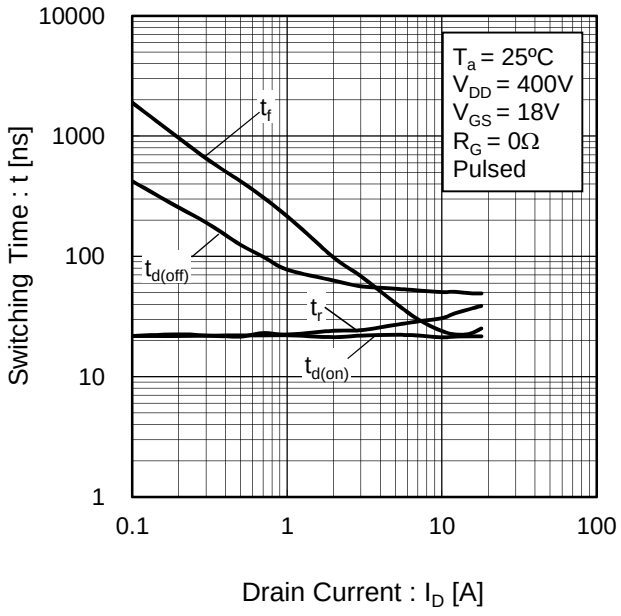
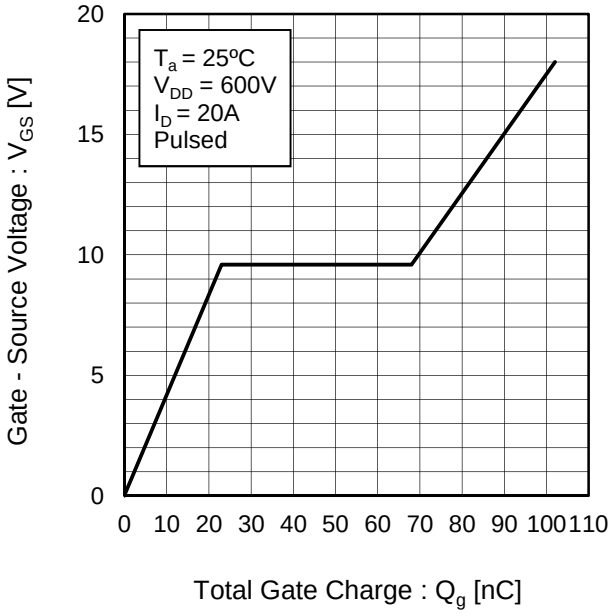


Fig.18 Dynamic Input Characteristics



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●Electrical characteristic curves

Fig.19 Typical Switching Loss vs. Drain - Source Voltage

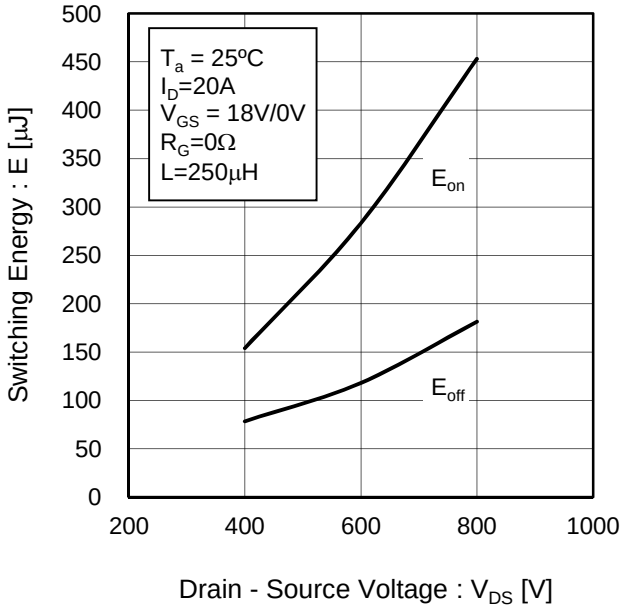


Fig.20 Typical Switching Loss vs. Drain Current

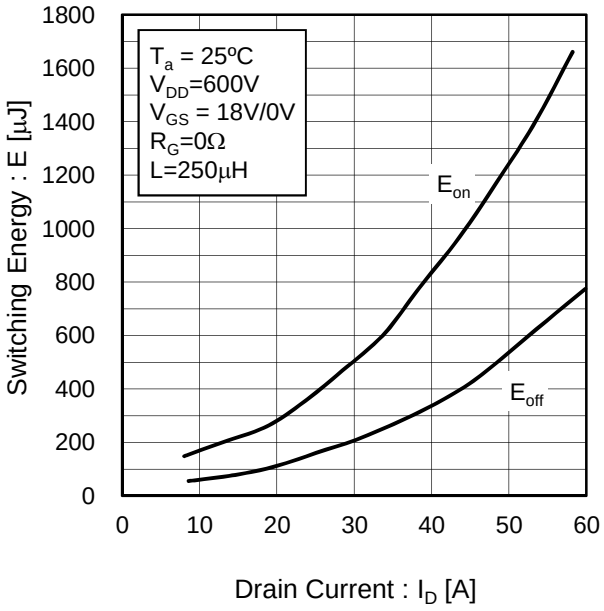
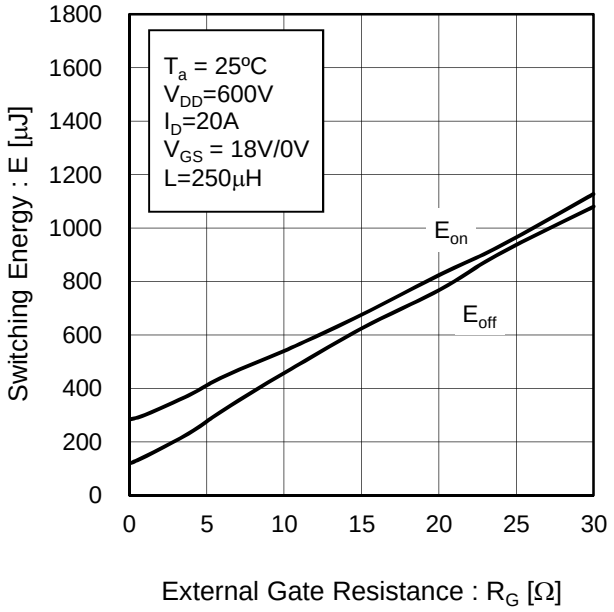


Fig.21 Typical Switching Loss vs. External Gate Resistance



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●Electrical characteristic curves

Fig.22 Inverse Diode Forward Current vs. Source - Drain Voltage

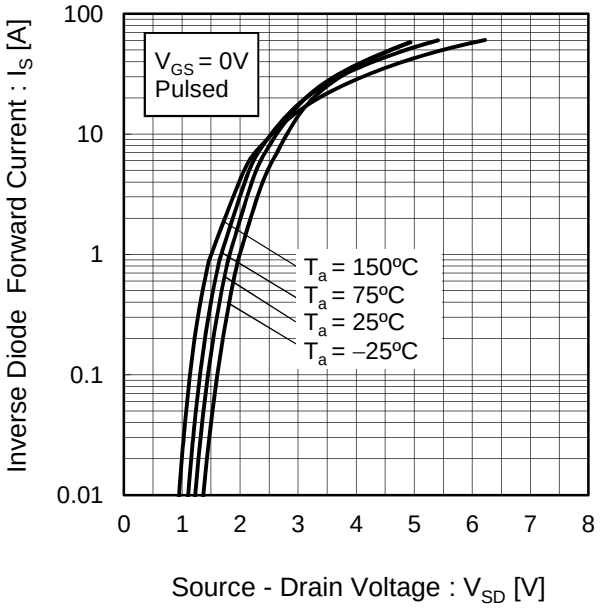
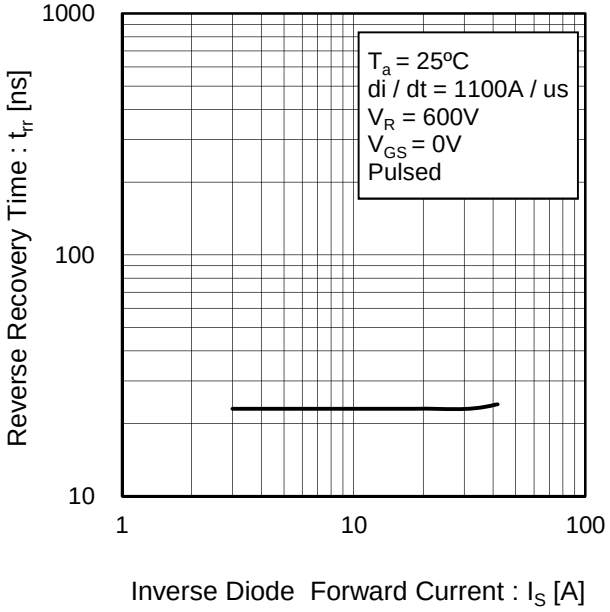


Fig.23 Reverse Recovery Time vs.Inverse Diode Forward Current



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●Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

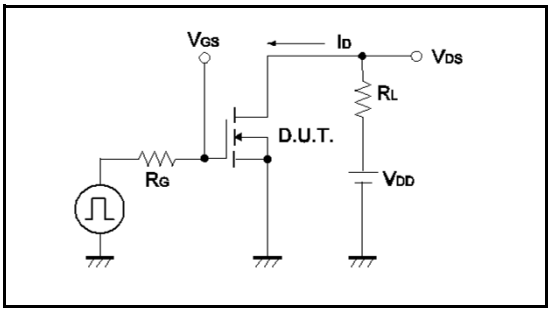


Fig.1-2 Switching Waveforms

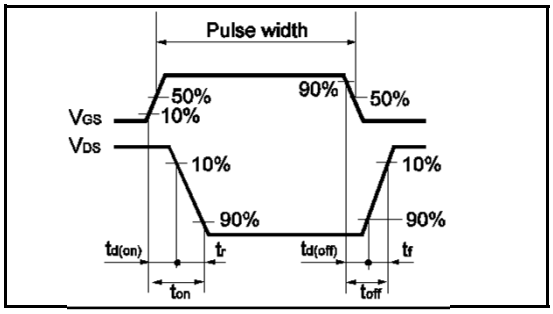


Fig.2-1 Gate Charge Measurement Circuit

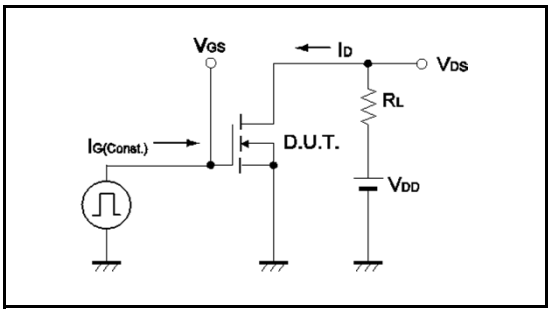


Fig.2-2 Gate Charge Waveform

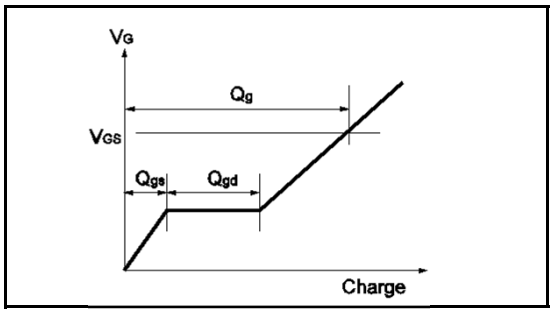


Fig.3-1 Switching Energy Measurement Circuit

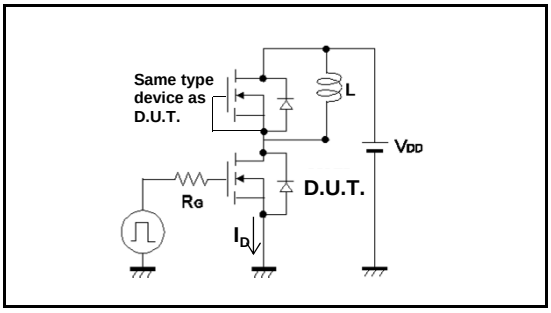


Fig.3-2 Switching Waveforms

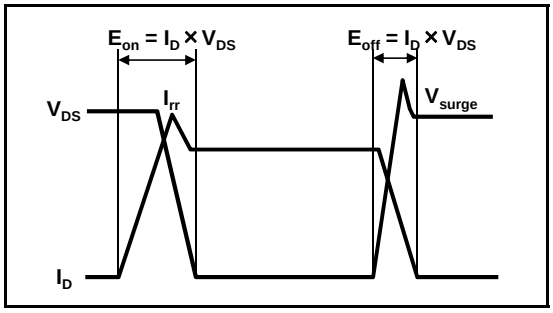


Fig.4-1 Reverse Recovery Time Measurement Circuit

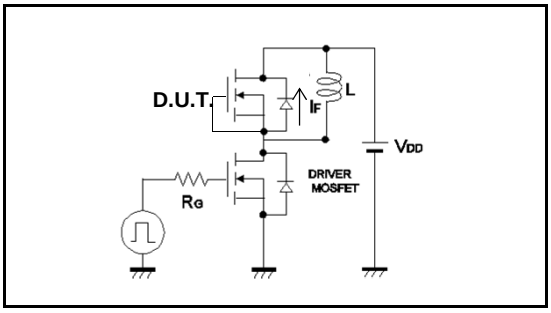
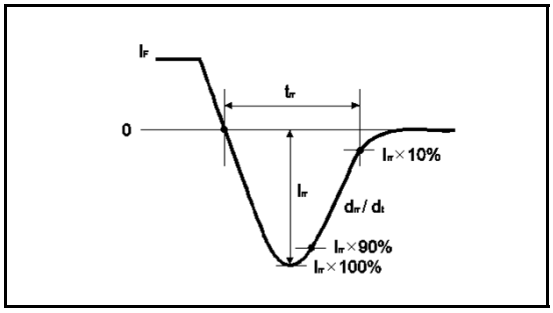


Fig.4-2 Reverse Recovery Waveform



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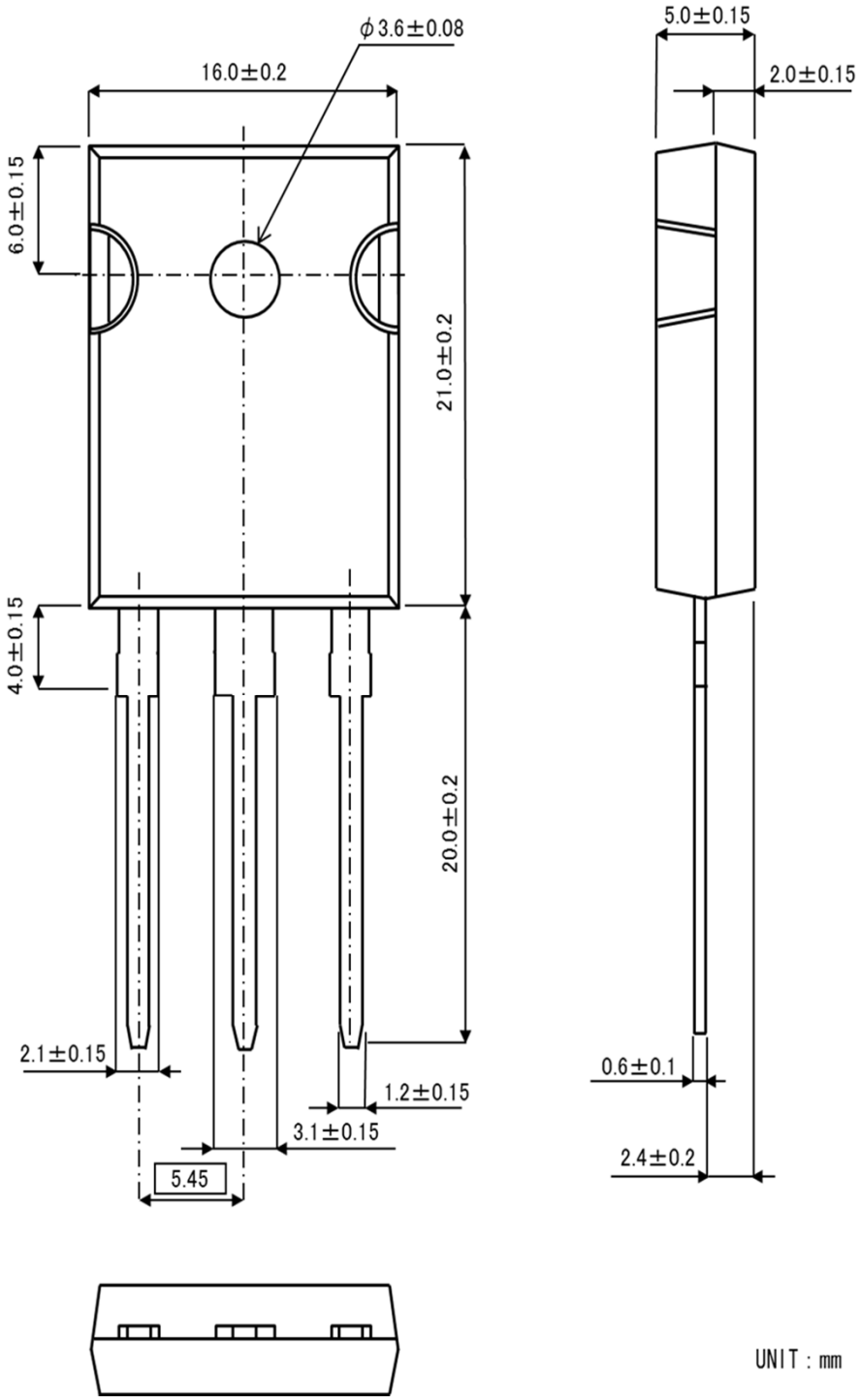
●Dimensions

TO-247



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9) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.

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SCT3040KL - Web Page

Buy

Distribution Inventory

Part Number	SCT3040KL
Package	TO-247N
Unit Quantity	450
Minimum Package Quantity	30
Packing Type	Tube
Constitution Materials List	inquiry
RoHS	Yes